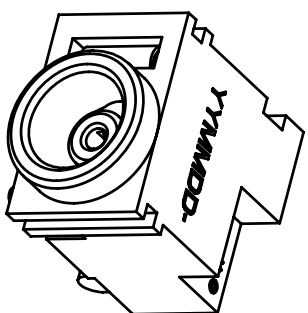


1. ELECTRICAL CHARACTERISTICS:

- 1-2. CONTACT RESISTANCE: 30m Ω MAX.(INITIAL)
1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE
1-4. INSULATION RESISTANCE: 100M Ω MIN. MEASURED BY 500 VDC
2. MECHANICAL CHARACTERISTICS:
2-1. INSERTION FORCE : 3.0 KG Max.
2-2. WITHDRAWAL FORCE : 1.0~3.0 KG

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- 2-1. INSERTION FORCE :3.0 KG Max.
2-2. WITHDRAWAL FORCE : 1.0~3.0 KG

3. LIFE TEST: 5,000 CYCLES MIN.

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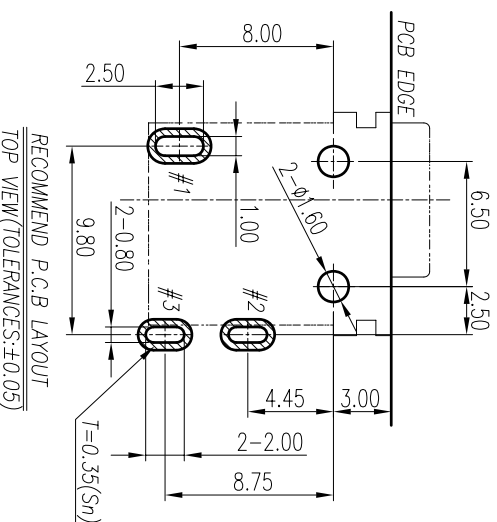
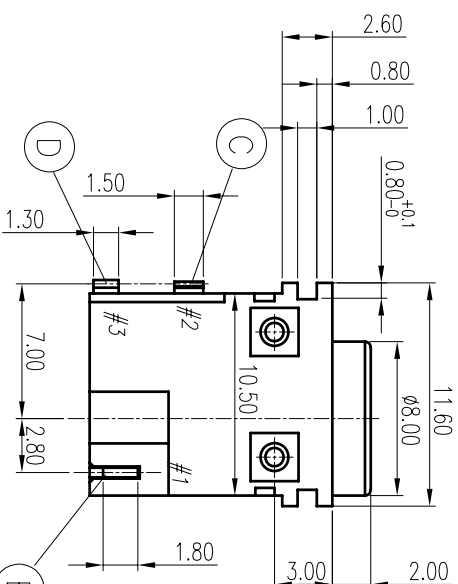
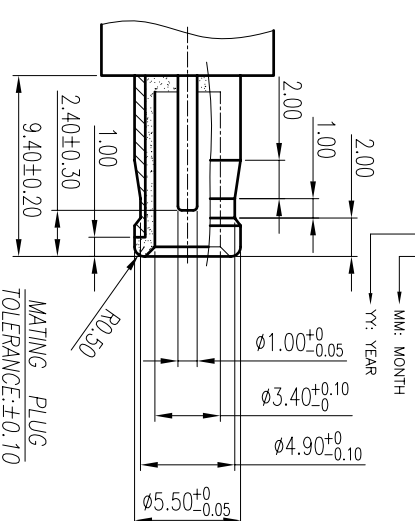
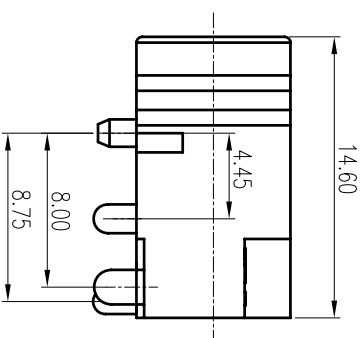
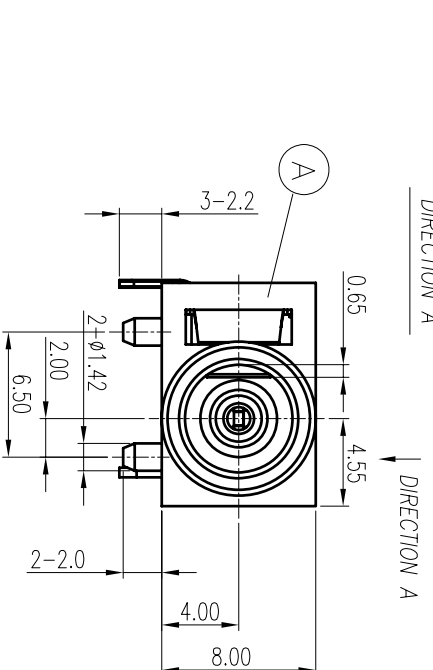
4. TO CONFORM TO SINGATRON HAZARDOUS SUBSTANE FREE SPEC.

5. HALOGEN FREE PRODUCT IDENTIFICATION MARK ON JACK:

6. HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:

7. FOR REFLOW SOLDERING LEAD-FREE PROCESS.

8.PRINTED DATE CODE" ~~YMMDD-~~ ON TOP OF CONNECTOR.



D	SHUNT	1	BRASS; 0.4T	GOLD FLASH ON CONTACT AREA Sn 120μ ON SOLDER TAIL; ALL OVER IN 60μ"
C	TIP	1	COPPER ALLOY; 0.25T	GOLD FLASH ON CONTACT AREA Sn 120μ ON SOLDER TAIL; ALL OVER IN 60μ"
B	TERMINAL	1	COPPER ALLOY; 0.5T	GOLD FLASH ON CONTACT AREA Sn 120μ ON SOLDER TAIL; ALL OVER IN 60μ"
A	BODY	1	HIGH THERMOPLASTIC TEMP. UL 94V-0	BLACK
UNLESS OTHERWISE SPECIFIED TOLERANCES		 Singaton Enterprise Co., Ltd. 信音企業股份有限公司		
DECIMALS:	ANGLES:	TITLE	DC JACK	
X : ±0.5	X : ±2°	DWN	SNG2008.12.10 PART NO.2DC3010-000111	
X.X : ±0.3	X.X : ±1°	CHKD	Boye SCALE:1:1 UNIT: mm	
X.XX : ±0.2		APVD	Mox SIZE: A3 SHEET:1 OF 1 REV:A	
CUSTOMER COPY				

CUSTOMER COPY